Product data sheet

1. General description

Dual ultrafast power diodes in a SOT78 (TO-220AB) plastic package. These diodes are rugged with a guaranteed electrostatic discharge voltage capability.

2. Features and benefits

- Fast switching
- Low on-state losses
- Guaranteed ESD capability
- Low thermal resistance
- High thermal cycling performance
- Soft recovery minimizes power-consuming oscillations

3. Applications

· Output rectifiers in high-frequency switched-mode power supplies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Va	lues		Unit			
Absolute maximum rating										
V_{RRM}	repetitive peak reverse voltage			2	00		V			
I _{O(AV)}	average output current	square-wave pulse; δ = 0.5; $T_{mb} \le$ 119 °C; both diodes conducting; Fig. 1; Fig. 2			10		Α			
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 119 °C; per diode; square-wave pulse	10			A				
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; sine-wave pulse; $T_{j(init)}$ = 25 °C; per diode	50		A					
		t_p = 8.3 ms; sine-wave pulse; $T_{j(init)}$ = 25 °C; per diode	55		A					
Symbol	Parameter	Conditions	Min Typ Max		Unit					
Static ch	aracteristics									
V _F	forward voltage	I _F = 5 A; T _j = 150 °C; <u>Fig. 4</u>		-	8.0	0.895	V			
Dynamic	characteristics									
t _{rr}	reverse recovery time $I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/}\mu\text{s}$; $T_i = 25 \text{ °C}$; ramp recovery; Fig. 5			-	15	25	ns			
Electrostatic discharge										
V _{ESD}	electrostatic discharge voltage	HBM; C = 250 pF; R = 1.5 kΩ; all pins		-	-	8	kV			

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	mb	
2	K	cathode	7 7	[5]
3	A2	anode 2		A1 A2
mb	K	K mounting base; cathode		K sym125
			ППП ПППП	

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BYQ28E-200E	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

7. Marking

Table 4. Marking codes

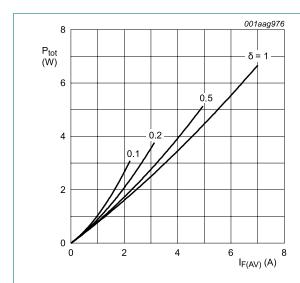
Type number	Marking codes
BYQ28E-200E	BYQ28E-200E

8. Limiting values

Table 5. Limiting values

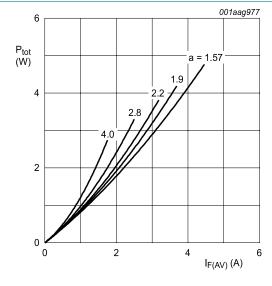
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		200	V
V_{RWM}	crest working reverse voltage		200	V
V_R	reverse voltage	DC	200	V
I _{O(AV)}	average output current	δ = 0.5; square-wave pulse; T _{mb} ≤ 119 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u>	10	А
I _{FRM}	repetitive peak forward current	$δ = 0.5$; $t_p = 25 \mu s$; $T_{mb} \le 119 °C$; per diode; square-wave pulse	10	А
I _{FSM}	non-repetitive peak forward current	t_p = 10 ms; sine-wave pulse; $T_{j(init)}$ = 25 °C; per diode	50	А
		t_p = 8.3 ms; sine-wave pulse; $T_{j(init)}$ = 25 °C; per diode	55	А
I _{RRM}	repetitive peak reverse current	δ = 0.001; t_p = 2 μ s	0.2	А
I _{RSM}	non-repetitive peak reverse current	t _p = 100 μs	0.2	А
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C
Electrosta	tic discharge			
V _{ESD}	electrostatic discharge voltage	HBM; C = 250 pF; R = 1.5 kΩ; all pins	8	kV



 $I_{F(AV)} = I_{F(RMS)} \times \sqrt{\delta}$

Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values; per diode



 $a = form factor = I_{F(RMS)} / I_{F(AV)}$

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; maximum values; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to	with heatsink compound; both diodes conducting	-	-	3	K/W
	mounting base	with heatsink compound; per diode; Fig. 3	-	-	4.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient		-	60	-	K/W

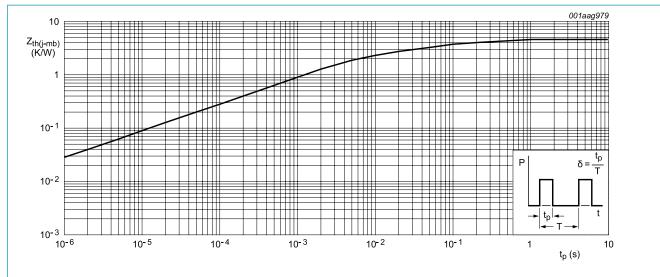
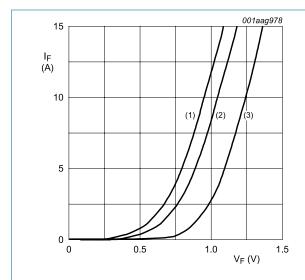


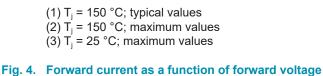
Fig. 3. Transient thermal impedance from junction to mounting base as a function of pulse width

10. Characteristics

Table 7 Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward voltage	I _F = 5 A; T _j = 150 °C; <u>Fig. 4</u>	-	0.8	0.895	V
		I _F = 5 A; T _j = 25 °C; <u>Fig. 4</u>	-	0.95	1.1	V
		I _F = 10 A; T _j = 25 °C; <u>Fig. 4</u>	-	1.1	1.25	V
I _R	reverse current	V _R = 200 V; T _j = 25 °C	-	2	10	μA
		V _R = 200 V; T _j = 100 °C	-	0.1	0.2	mA
Dynamic	characteristics					
Q_r	recovered charge	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 20 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 5$	-	4	9	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}$; $V_R = 30 \text{ V}$; $dI_F/dt = 100 \text{ A/µs}$; ramp recovery; $T_j = 25 \text{ °C}$; Fig. 5	-	15	25	ns
		$I_F = 0.5 \text{ A}$; $I_R = 1 \text{ A}$; step recovery; $T_j = 25 \text{ °C}$; Fig. 6	-	10	20	ns
I _{RM}	peak reverse recovery current	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 20 \text{ A/µs};$ $T_j = 25 \text{ °C}; \frac{\text{Fig. 5}}{}$	-	0.4	0.7	А
V_{FR}	forward recovery voltage	I _F = 1 A; dI _F /dt = 10 A/μs; T _j = 25 °C; Fig. 7	-	1	-	V





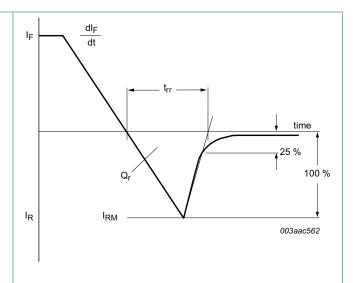
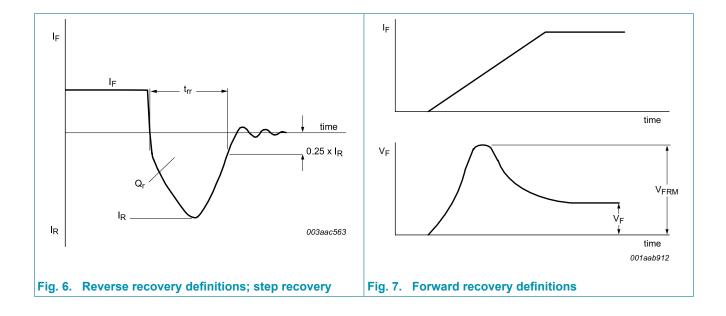


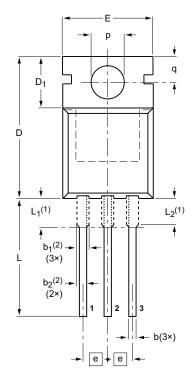
Fig. 5. Reverse recovery definitions; ramp recovery

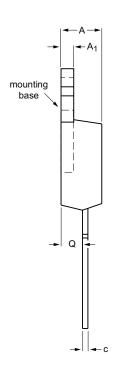


11. Package outline

Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB

SOT78





0 5 10 mm

DIMENSIONS (mm are the original dimensions)

UNIT	А	A ₁	b	b ₁ ⁽²⁾	b ₂ ⁽²⁾	С	D	D ₁	E	е	L	L ₁ ⁽¹⁾	L ₂ ⁽¹⁾ max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

Notes

- 1. Lead shoulder designs may vary.
- 2. Dimension includes excess dambar.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT78		3-lead TO-220AB	SC-46		08-04-23 08-06-13

12. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes					
BYQ28E-200E v.5	20180605	Product data sheet	-	BYQ28E-200E v.4					
Modifications:	Change from NXP version to WeEn version								
BYQ28E-200E v.4	20110714	Product data sheet	-	BYQ28E_SERIES v.3					
Modifications:	 Type number BYQ28E-200E separated from data sheet BYQ28E_SERIES v.3. The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 								
BYQ28E_SERIES v.3	19981001	Product specification	-	BYQ28E_SERIES v.2					

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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